

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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amdt
12-5-00

In re application of

Kazuto NISHIDA

Serial No. 09/331,763

Filed June 25, 1999



: Docket No.00177/526327

: Group Art Unit 3729

: Examiner R. Sands

METHOD AND APPARATUS FOR
MOUNTING ELECTRONIC COMPONENT
ON CIRCUIT BOARD

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AMENDMENT

Assistant Commissioner for Patents,
Washington, D.C.

Sir:

In response to the Office Action of May 24, 2000, the period for response to which having been extended by three months to November 24, 2000, please amend the above-identified U.S. Patent application as follows:

IN THE ABSTRACT

Please amend the abstract as follows:

Line 3, after "chip" delete "1" and after "board" delete "4".

Line 4, after "bumps" delete "3" and change "2 on" to --of--.

Line 7, after "resin" delete "6".

Line 10, after "head" delete "8".

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975